

Engineering Development Model

RF Transformer

TC1-ED12608/1

Impedance Ratio : 1

Important Note

This model has been designed, built and tested in our engineering department. Performance data represents model capability. At present it is a non-catalog model. On request, we can supply a final specification sheet, part number and price/delivery information.



Please click "Back", and then click "Contact Us" for Applications support.

CASE STYLE : AT224

ELECTRICAL SPECIFICATIONS 50Ω @ +25°C				
Parameter		Min.	Typ.	Max. Units
Frequency		0.4		600 MHz
Insertion Loss *	3 dB Bandwidth		0.4 - 600	MHz
	2 dB Bandwidth		0.5 - 500	MHz
	1 dB Bandwidth		3 - 100	MHz

Note:

* Insertion Loss is referenced to mid-band loss, 0.76dB typ.

MAXIMUM RATINGS	
Operating Temperature	-20°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25 W
DC Current	30 mA

PIN CONNECTIONS	
PRIMARY DOT	6
PRIMARY	4
SECONDARY	1
SECONDARY CT	3
ISOLATE	2

Configuration : C

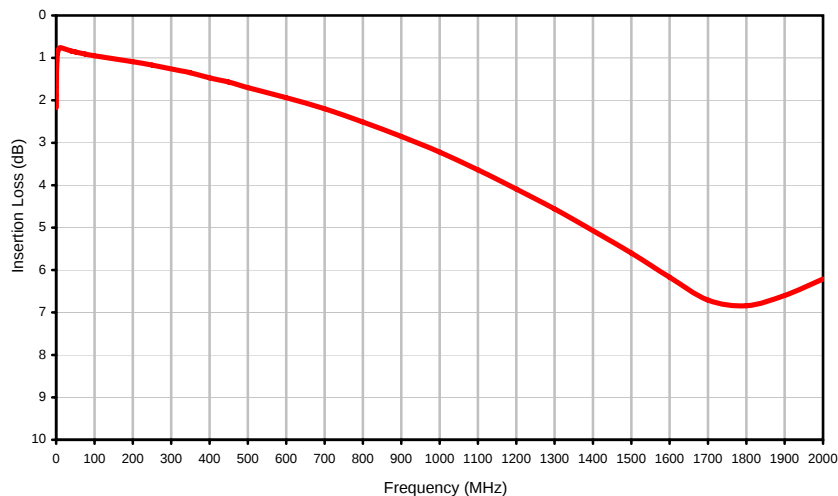


Typical Performance Data

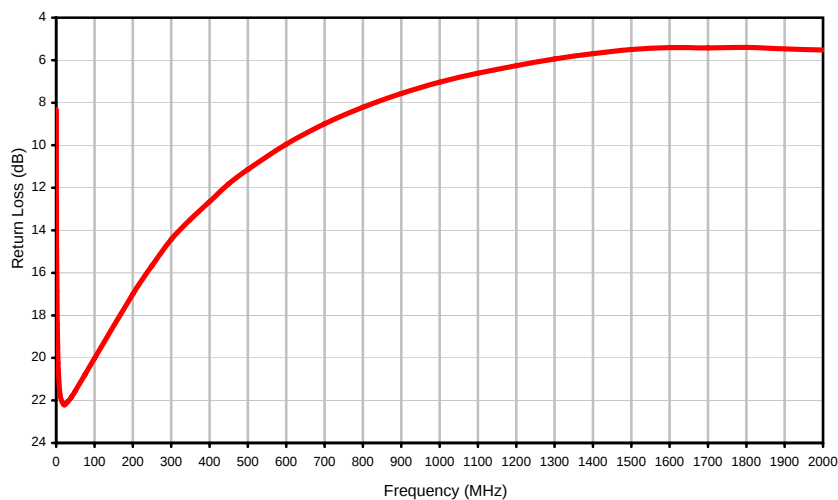
FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
0.30	2.17	8.33
0.40	1.88	9.99
0.50	1.70	11.15
0.60	1.59	12.02
0.70	1.51	12.72
0.80	1.44	13.28
0.90	1.39	13.76
1.00	1.34	14.17
2.00	1.06	16.87
3.00	0.93	18.42
4.00	0.86	19.49
5.00	0.82	20.25
10.00	0.76	21.73
20.00	0.78	22.20
30.00	0.81	22.06
40.00	0.84	21.84
50.00	0.86	21.55
75.00	0.91	20.79
100.00	0.95	20.02
200.00	1.09	17.00
250.00	1.17	15.66
300.00	1.26	14.43
350.00	1.35	13.49
400.00	1.47	12.65
450.00	1.57	11.82
500.00	1.70	11.14
600.00	1.94	9.95
700.00	2.20	8.99
800.00	2.51	8.21
900.00	2.85	7.57
1000.00	3.22	7.03
1100.00	3.64	6.61
1200.00	4.09	6.26
1300.00	4.56	5.94
1400.00	5.07	5.69
1500.00	5.60	5.50
1600.00	6.17	5.41
1700.00	6.71	5.42
1800.00	6.84	5.40
1900.00	6.60	5.47
2000.00	6.21	5.52

Typical Performance Curves

Insertion Loss

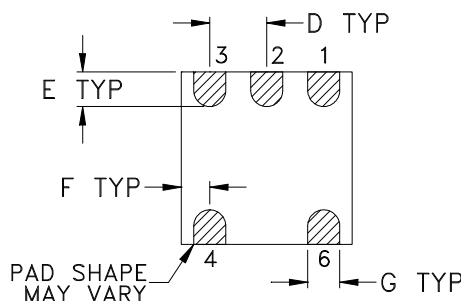
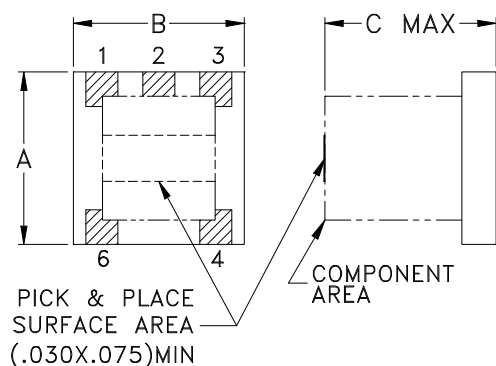


Return Loss

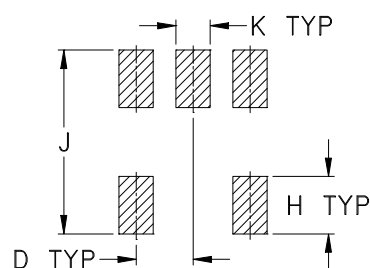


Outline Dimensions

AT224



PCB Land Pattern



Suggested Layout,
Tolerance to be within ± 0.002

CASE #	A	B	C	D	E	F	G	H	J	K	L	WT. GRAMS
AT224	.150 (3.81)	.150 (3.81)	.150 (3.81)	.050 (1.27)	.030 (0.76)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	-- --	.10

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Open style, ceramic base.
- Termination finish:
For RoHS Case Styles: 2-10 μ inch (.05-.25 microns) Gold over 100-300 μ inch (2.54-7.62 microns) Nickel plate.
All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

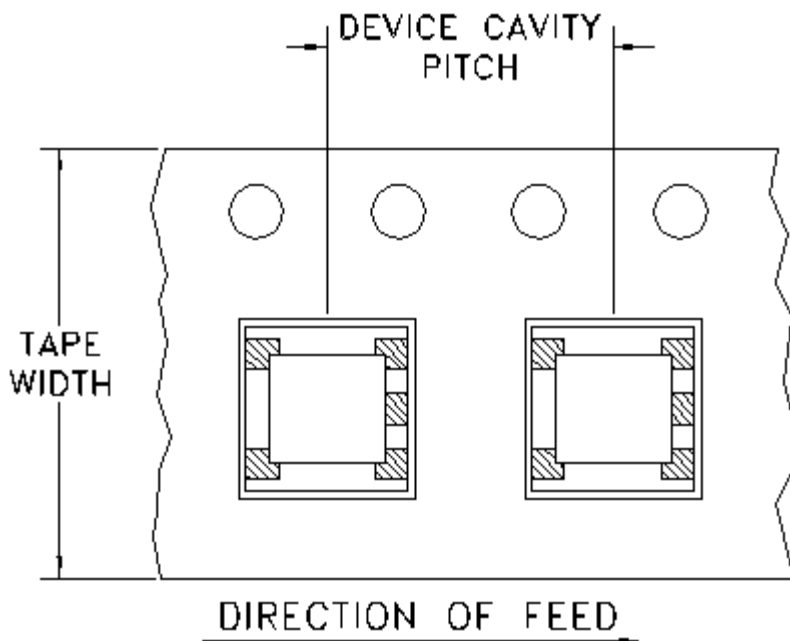


The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F17

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
		13	Standard	1000
				2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



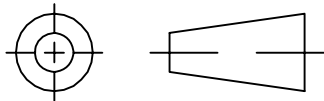
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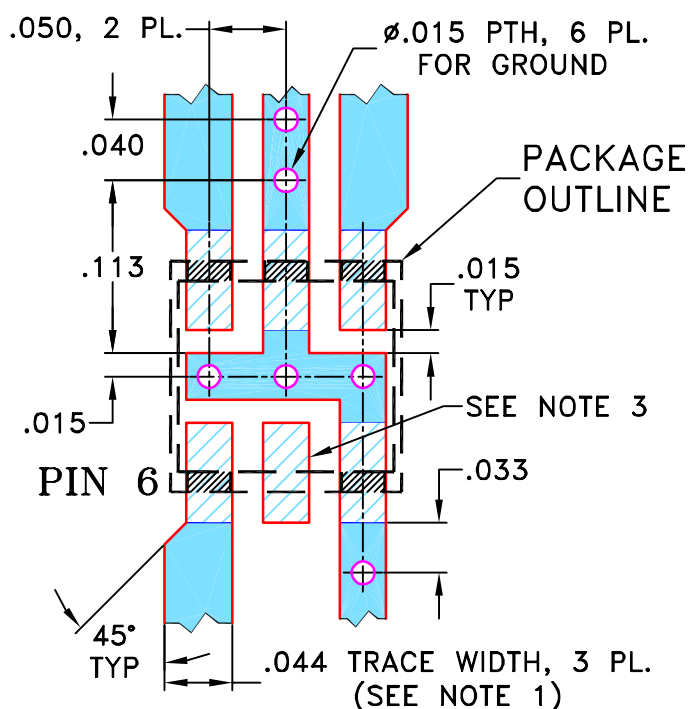
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M106563	NEW RELEASE	08/23/06	AV	IG

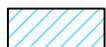
SUGGESTED MOUNTING CONFIGURATION
FOR AT224/DB714 CASE STYLE, "gs/ha/hd" PIN CONNECTIONS
(FOR SINGLE ENDED TO BALANCED APPLICATION)



- NOTES:** 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020" $\pm$.0015"; COPPER: 1/2 OZ. ON EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
 3. THIS PAD IS NOT REQUIRED FOR AT224 CASE STYLE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

TOLERANCES ON:

2 PL DECIMALS $\pm$ 3 PL DECIMALS $\pm$.005ANGLES $\pm$ FRACTIONS $\pm$

DRAWN

AV

07/28/06

CHECKED

IL

08/23/06

APPROVED

IG

08/23/06



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13 Neptune Avenue
Brooklyn NY 11235

PL, gs/ha/hd, AT224/DB714, TC/TCM, TB-145

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ASHEETA1.DWG REV:A DATE:01/12/95

SIZE
A

CODE IDENT
15542

DRAWING NO:
98-PL-244

REV:
OR

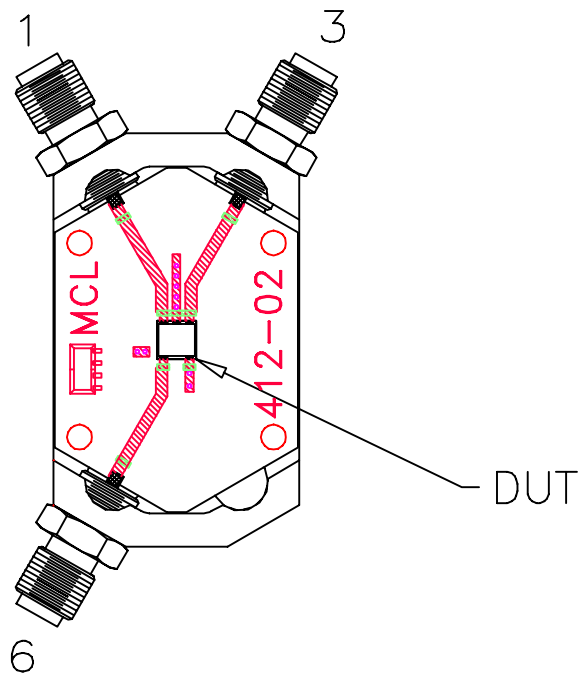
FILE: 98PL244

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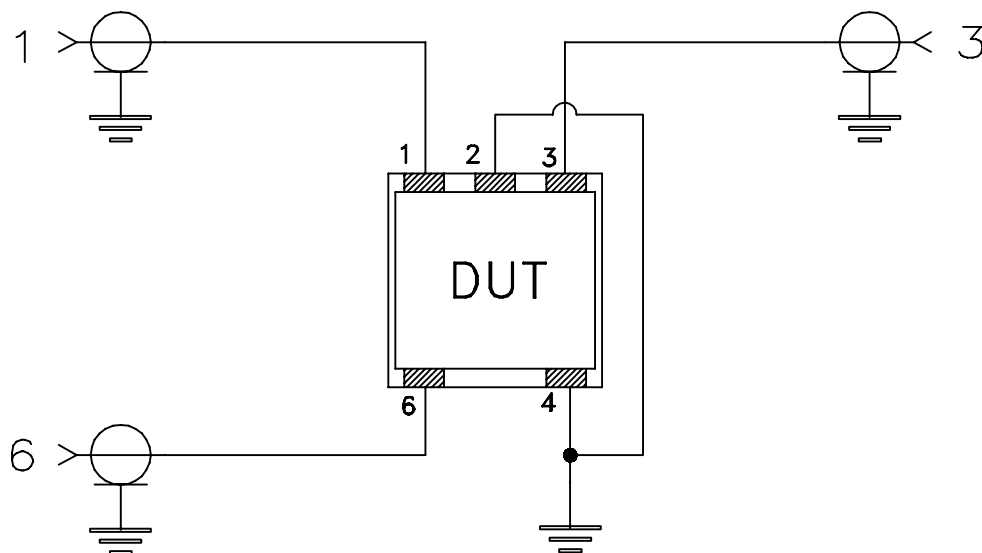
SHEET: 1 OF 1

Evaluation Board and Circuit

For Pin Connections refer to Data Sheet of the DUT



TB-145



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: Rogers R04350B or its equivalent, Dielectric Constant=3.5, Thickness=.020"

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All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215